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Understanding Embedded - Microprocessors

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Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Obsolete
Core Processor	Z8S180
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	20MHz
Co-Processors/DSP	-
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	64-DIP (0.750", 19.05mm)
Supplier Device Package	64-DIP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8s18020psg1960

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

PIN DESCRIPTIONS

A0–A19 Address Bus (Output, 3-state). A0–A19 form a 20-bit address bus. The Address Bus provides the address for memory data bus exchanges (up to 1 MB) and I/O data bus exchanges (up to 64 KB). The address bus enters a high–impedance state during reset and external bus acknowledge cycles. Address line A18 is multiplexed with the output of PRT channel 1 (T_{OUT} , selected as address output on reset), and address line A19 is not available in DIP versions of the Z8S180.

BUSACK. Bus Acknowledge (Output, active Low). BUSACK indicates that the requesting device, the MPU address and data bus, and some control signals enter their highimpedance state.

BUSREQ. Bus Request (Input, active Low). This input is used by external devices (such as DMA controllers) to request access to the system bus. This request demands a higher priority than $\overline{\text{NMI}}$ and is always recognized at the end of the current machine cycle. This signal stops the CPU from executing further instructions, places addresses, data buses, and other control signals into the high-impedance state.

CKAO, **CKA1**. Asynchronous Clock 0 and 1 (bidirectional). When in output mode, these pins are the transmit and receive clock outputs from the ASCI baud rate generators. When in input mode, these pins serve as the external clock inputs for the ASCI baud rate generators. CKAO is multiplexed with DREQO, and CKA1 is multiplexed with TENDO.

CKS. Serial Clock (bidirectional). This line is the clock for the CSI/O channel.

CTSO–**CTS1**. Clear to send 0 and 1 (Inputs, active Low). These lines are modem control signals for the ASCI channels. $\overline{\text{CTS1}}$ is multiplexed with RXS.

D0–D7. Data Bus = (bidirectional, 3-state). D0–D7 constitute an 8-bit bidirectional data bus, used for the transfer of information to and from I/O and memory devices. The data bus enters the high-impedance state during reset and external bus acknowledge cycles.

DCDO. Data Carrier Detect 0 (Input, active Low); a programmable modem control signal for ASCI channel 0.

DREQO, **DREQ1**. DMA Request 0 and 1 (Input, active Low). **DREQ** is used to request a DMA transfer from one of the on-chip DMA channels. The DMA channels monitor these inputs to determine when an external device is ready for a READ or WRITE operation. These inputs can be programmed to be either level or edge sensed. **DREQO** is multiplexed with CKAO.

E. Enable Clock (Output). This pin functions as a synchronous, machine-cycle clock output during bus transactions.

EXTAL. External Clock Crystal (Input). Crystal oscillator connections. An external clock can be input to the Z8S180/Z8L180 on this pin when a crystal is not used. This input is Schmitt triggered.

HALT. HALT/SLEEP (Output, active Low). This output is asserted after the CPU executes either the HALT or SLEEP instruction and is waiting for either a nonmaskable or a maskable interrupt before operation can resume. It is also used with the $\overline{M1}$ and ST signals to decode the status of the CPU machine cycle.

INTO. Maskable Interrupt Request 0 (Input, active Low). This signal is generated by external I/O devices. The CPU honors these requests at the end of the current instruction cycle as long as the $\overline{\text{NMI}}$ and $\overline{\text{BUSREQ}}$ signals are inactive. The CPU acknowledges this interrupt request with an interrupt acknowledge cycle. During this cycle, both the $\overline{\text{M1}}$ and $\overline{\text{IORQ}}$ signals become active.

INT1, **INT2**. Maskable Interrupt Request 1 and 2 (Inputs, active Low). This signal is generated by external I/O devices. The CPU honors these requests at the end of the current instruction cycle as long as the NMI, BUSREQ, and INTO signals are inactive. The CPU acknowledges these requests with an interrupt acknowledge cycle. Unlike the acknowledgment for INTO, neither the M1 or IORQ signals become active during this cycle.

IORQ. I/O Request (Output, active Low, 3-state). **IORQ** indicates that the address bus contains a valid I/O address for an I/O READ or I/O WRITE operation. **IORQ** is also generated, along with $\overline{M1}$, during the acknowledgment of the INTO input signal to indicate that an interrupt response vector can be place onto the data bus. This signal is analogous to the IOE signal of the Z64180.

M1. Machine Cycle 1 (Output, active Low). Together with $\overline{\text{MREQ}}$, $\overline{\text{M1}}$ indicates that the current cycle is the opcodefetch cycle of instruction execution. Together with $\overline{\text{IORQ}}$, $\overline{\text{M1}}$ indicates that the current cycle is for interrupt acknowledgment. It is also used with the $\overline{\text{HALT}}$ and ST signal to decode the status of the CPU machine cycle. This signal is analogous to the $\overline{\text{LIR}}$ signal of the Z64180.

MREQ. Memory Request (Output, active Low, 3-state). **MREQ** indicates that the address bus holds a valid address for a memory READ or memory WRITE operation. This signal is analogous to the $\overline{\text{ME}}$ signal of Z64180.

NMI. Nonmaskable Interrupt (Input, negative edge triggered). $\overline{\text{NMI}}$ demands a higher priority than $\overline{\text{INT}}$ and is al-

A18/TOUT	During RESET, this pin is initialized as A18. If either the TOC1 or the TOC0 bit of the Timer Control register (TCR) is set to 1, the T_{OUT} function is selected. If TOC1 and TOC0 are cleared to 0, the A18 function is selected.
CKA0/DREQ0	During RESET, this pin is initialized as CKA0. If either DM1 or SM1 in the DMA Mode register (DMODE) is set to 1, the DREQ0 function is selected.
CKA1/TENDO	During RESET, this pin is initialized as CKA1. If the CKA1D bit in ASCI control register ch1 (CNTLA1) is set to 1, the TENDO function is selected. If the CKA1D bit is set to 0, the CKA1 function is selected.
RXS/CTS1	During RESET, this pin is initialized as RXS. If the CTS1E bit in the ASCI status register ch1 (STAT1) is set to 1, the $\overline{\text{CTS1}}$ function is selected. If the CTS1E bit is set to 0, the RXS function is selected.

Table 4. Multiplexed Pin Descriptions

ARCHITECTURE

The Z180 combines a high-performance CPU core with a variety of system and I/O resources useful in a broad range of applications. The CPU core consists of five functional blocks: clock generator, bus state controller, Interrupt controller, memory management unit (MMU), and the central processing unit (CPU). The integrated I/O resources make up the remaining four functional blocks: direct memory access (DMA) control (2 channels), asynchronous serial communication interface (ASCI, 2 channels) programmable reload timers (PRT, 2 channels), and a clock serial I/O (CSI/O) channel.

Clock Generator. This logic generates a system clock from an external crystal or clock input. The external clock is divided by 2 or 1 and provides the timing for both internal and external devices.

Bus State Controller. This logic performs all of the status and bus-control activity associated with the CPU and some on-chip peripherals. Also includes wait-state timing, reset cycles, DRAM refresh, and DMA bus exchanges.

Interrupt Controller. This logic monitors and prioritizes the variety of internal and external interrupts and traps to provide the correct responses from the CPU. To maintain compatibility with the Z80 CPU, three different interrupts modes are supported.

Memory Management Unit. The MMU allows the user to map the memory used by the CPU (logically only 64KB) into the 1-MB addressing range supported by the Z8S180/Z8L180. The organization of the MMU object

Central Processing Unit. The CPU is microcoded to provide a core that is object-code compatible with the Z80 CPU. It also provides a superset of the Z80 instruction set, including 8-bit multiplication. The core is modified to allow many of the instructions to execute in fewer clock cycles.

DMA Controller. The DMA controller provides highspeed transfers between memory and I/O devices. Transfer operations supported are memory-to-memory, memory to/from I/O, and I/O-to-I/O. Transfer modes supported are request, burst, and cycle steal. DMA transfers can access the full 1-MB address range with a block length up to 64 KB, and can cross over 64K boundaries.

Asynchronous Serial Communication Interface (ASCI).

The ASCI logic provides two individual full-duplex UARTs. Each channel includes a programmable baud rate generator and modem control signals. The ASCI channels can also support a multiprocessor communication format as well as break detection and generation

Programmable Reload Timers (PRT). This logic consists of two separate channels, each containing a 16-bit counter (timer) and count reload register. The time base for the counters is derived from the system clock (divided by 20) before reaching the counter. PRT channel 1 provides an optional output to allow for waveform generation.

This condition provides a technique for synchronization with high-speed external events without incurring the latency imposed by an interrupt-response sequence. Figure 14 depicts the timing for exiting SLEEP mode due to an interrupt request.

Note: The Z8S180/Z8L180 takes about 1.5 clock ticks to restart.



IOSTOP Mode. IOSTOP mode is entered by setting the IOSTOP bit of the I/O Control Register (ICR) to 1. In this case, on-chip I/O (ASCI, CSI/O, PRT) stops operating. However, the CPU continues to operate. Recovery from IOSTOP mode is performed by resetting the IOSTOP bit in ICR to 0.

SYSTEM STOP Mode. SYSTEM STOP mode is the combination of SLEEP and IOSTOP modes. SYSTEM STOP mode is entered by setting the IOSTOP bit in ICR to 1 followed by execution of the SLP instruction. In this mode, on-chip I/O and CPU stop operating, reducing power consumption, but the PHI output continues to operate. Recovery from SYSTEM STOP mode is the same as recovery from SLEEP mode except that internal I/O sources (disabled by IOSTOP) cannot generate a recovery interrupt.

IDLE Mode. Software puts the Z8S180/Z8L180 into this mode by performing the following actions:

- Set the IOSTOP bit (ICR5) to 1
- Set CCR6 to 0
- Set CCR3 to 1
- Execute the SLP instruction

The oscillator keeps operating but its output is blocked to all circuitry including the PHI pin. DRAM refresh and all

internal devices stop, but external interrupts can occur. Bus granting to external Masters can occur if the BREST bit in the CPU control Register (CCR5) was set to 1 before IDLE mode was entered.

The Z8S180/Z8L180 leaves IDLE mode in response to a Low on RESET, an external interrupt request on NMI, or an external interrupt request on INTO, INT1 or INT2 that is enabled in the INT/TRAP Control Register. As previously described for SLEEP mode, when the Z8S180/Z8L180 leaves IDLE mode due to an NMI, or due to an enabled external interrupt request when the IEF flag is 1 due to an El instruction, the device starts by performing the interrupt with the return address of the instruction after the SLP instruction.

If an external interrupt enables the INT/TRAP control register while the IEF1 bit is 0, Z8S180/Z8L180 leaves IDLE mode; specifically, the processor restarts by executing the instructions following the SLP instruction.

Figure 15 indicates the timing for exiting IDLE mode due to an interrupt request.

Note: The Z8S180/Z8L180 takes about 9.5 clocks to restart.



Figure 15. Z8S180/Z8L180 IDLE Mode Exit Due To External Interrupt

While the Z8S180/Z8L180 is in IDLE mode, it grants the bus to an external Master if the BREXT bit (CCR5) is 1. Figure 16 depicts the timing for this sequence.

Note: A response to a bus request takes 8 clock cycles longer than in normal operation.

After the external Master negates the Bus Request, the Z8S180/Z8L180 disables the PHI clock and remains in IDLE mode.



STANDBY Mode (With or Without QUICK RECOVERY).

Software can put the Z8S180/Z8L180 into this mode by setting the IOSTOP bit (ICR5) to 1, CCR6 to 1, and executing the SLP instruction. This mode stops the on-chip oscillator and thus draws the least power of any mode, less than 10μ A.

As with IDLE mode, the Z8S180/Z8L180 leaves STANDBY mode in response to a Low on $\overline{\text{RESET}}$, on $\overline{\text{NMI}}$, or a Low on $\overline{\text{INTO-2}}$ that is enabled by a 1 in the corresponding bit in the INT/TRAP Control Register. This action grants the bus to an external Master if the BREXT bit in the CPU Control Register (CCR5) is 1. The time required for all of these operations is greatly increased by the necessity for restarting the on-chip oscillator, and ensuring that it stabilizes to square-wave operation.

When an external clock is connected to the EXTAL pin rather than a crystal to the XTAL and EXTAL pins and the external clock runs continuously, there is little necessity to use STANDBY mode because no time is required to restart the oscillator, and other modes restart faster. However, if external logic stops the clock during STANDBY mode (for example, by decoding HALT Low and M1 High for several clock cycles), then STANDBY mode can be useful to allow the external clock source to stabilize after it is re-enabled.

When external logic drives **RESET** Low to bring the device out of **STANDBY** mode, and a crystal is in use or an external clock source is stopped, the external logic must hold **RESET** Low until the on-chip oscillator or external clock source is restarted and stabilized.

The clock-stability requirements of the Z8S180/Z8L180 are much less in the divide-by-two mode that is selected by a RESET sequence and controlled by the Clock Divide bit in the CPU Control Register (CCR7). As a result, software performs the following actions:

- 1. Sets CCR7 to 0 for divide-by-two mode before an SLP instruction and STANDBY mode.
- 2. Delays setting CCR7 back to 1 for divide-by-one mode as long as possible to allow additional clock stabilization time after a RESET, interrupt, or in-line RESTART after an SLP 01 instruction.

If CCR6 is set to 1 before the SLP instruction places the MPU in STANDBY mode, the value of the CCR3 bit determines the length of the delay before the oscillator restarts and stabilizes when it leaves STANDBY mode due to an external interrupt request. When CCR3 is 0, the Z8S180/Z8L180 waits 2^{17} (131,072) clock cycles. When CCR3 is 1, it waits 64 clock cycles. This state is called QUICK RECOVERY mode. The same delay applies to grant-

DC CHARACTERISTICS-Z8S180

Table 6.	Z8S1	80 DC (Chara	cteristics
V _{DD} :	= 5V	±10%;	V _{SS}	= 0V

Symbol	ltem	Condition	Min	Тур	Max	Unit
V _{IH1}	Input H Voltage RESET, EXTAL, NMI		V _{DD} -0.6	—	V _{DD} +0.3	V
V _{IH2}	Input H Voltage Except RESET, EXTAL, NMI		2.0	_	V _{DD} +0.3	V
V _{IH3}	Input H Voltage CKS, CKA0, CKA1		2.4	_	V _{DD} +0.3	V
V _{IL1}	Input L Voltage RESET, EXTAL, NMI		-0.3	_	0.6	V
V _{IL2}	Input L Voltage Except RESET, EXTAL, NMI		-0.3	_	0.8	V
V _{OH}	Outputs H Voltage	$I_{OH} = -200 \mu A$	2.4	_		V
	All outputs	$I_{OH} = -20 \ \mu A$	V _{DD} –1.2	—	_	
V _{OL}	Outputs L Voltage All outputs	$I_{OL} = 2.2 \text{ mA}$	_	_	0.45	V
I	Input Leakage Current All Inputs Except XTAL, EXTAL	$V_{IN} = 0.5 \sim V_{DD} - 0.5$	_	_	1.0	μA
I _{TL}	Three State Leakage Current	$V_{IN} = 0.5 \sim V_{DD} - 0.5$		_	1.0	μA
¹ ا _{مم}	Power Dissipation	F = 10 MHz	_	25	60	mA
	(Normal Operation)	20		30	50	
		33		60	100	
	Power Dissipation	F = 10 MHz		2	5	
	(SYSTEM STOP mode)	20		3	6	
		33		5	9	
C _P	Pin Capacitance	$V_{IN} = 0_V, f = 1 MHz$ $T_A = 25°C$	_	_	12	pF
Note: 1. V _{IHmi}	$_{n} = V_{DD}$ -1.0V, $V_{ Lmax} = 0.8V$ (All	output terminals are at NO LO	AD.) V _{DD} = 5.	.0V.		

TIMING DIAGRAMS (Continued)



Notes:

 $^{*}T_{\text{DRQS}}$ and T_{DRQH} are specified for the rising edge of the clock followed by $T_{3}.$

 $^{*\,*}T_{DRQS}$ and T_{DRQH} are specified for the rising edge of the clock.

Figure 23. DMA Control Signals

TIMING DIAGRAMS (Continued)



Figure 27. Timer Output Timing



Figure 28. SLP Execution Cycle

CPU CONTROL REGISTER

CPU Control Register (CCR). This register controls the basic clock rate, certain aspects of Power-Down modes, and output drive/low-noise options (Figure 31).



Figure 31. CPU Control Register (CCR) Address 1FH

Bit 7. Clock Divide Select. If this bit is 0, as it is after a RE-SET, the Z8S180/Z8L180 divides the frequency on the XTAL pin(s) by two to obtain its Master clock PHI. If this bit is programmed as 1, the part uses the XTAL frequency as PHI without division.

If an external oscillator is used in divide-by-one mode, the minimum pulse width requirement provided in the AC Characteristics must be satisfied.

Bits 6 and 3. STANDBY/IDLE Control. When these bits are both 0, a SLP instruction makes the Z8S180/Z8L180 enter SLEEP or SYSTEM STOP mode, depending on the IOSTOP bit (ICR5).

When D6 is 0 and D3 is 1, setting the IOSTOP bit (ICR5) and executing a SLP instruction puts the Z8S180/Z8L180 into IDLE mode in which the on-chip oscillator runs, but its output is blocked from the rest of the part, including PHI out.

When D6 is 1 and D3 is 0, setting IOSTOP (ICR5) and executing a SLP instruction puts the part into STANDBY mode, in which the on-chip oscillator is stopped and the part allows 2^{17} (128K) clock cycles for the oscillator to stabilize when it restarts.

When D6 and D3 are both 1, setting IOSTOP (ICR5) and executing a SLP instruction puts the part into QUICK RE-COVERY STANDBY mode, in which the on-chip oscillator is stopped, and the part allows only 64 clock cycles for the oscillator to stabilize when it restarts.

The latter section, HALT and LOW POWER modes, describes the subject more fully.

Bit 5 BREXT. This bit controls the ability of the Z8S180/Z8L180 to honor a bus request during STANDBY mode. If this bit is set to 1 and the part is in STANDBY mode, a BUSREQ is honored after the clock stabilization timer is timed out.

Bit 4 LNPHI. This bit controls the drive capability on the PHI Clock output. If this bit is set to 1, the PHI Clock output is reduced to 33 percent of its drive capability.

ZiLOG

Bit 2 LNIO. This bit controls the drive capability of certain external I/O pins of the Z8S180/Z8L180. When this bit is set to 1, the output drive capability of the following pins is reduced to 33 percent of the original drive capability:

RTSO	TxS
CKA1/TEND0	CKA0/DREQ0
TXA0	TXA1
TENDi	CKS

Bit 1 LNCPUCTL. This bit controls the drive capability of the CPU Control pins. When this bit is set to 1, the output drive capability of the following pins is reduced to 33 percent of the original drive capability:

BUSACK	RD
WR	<u>M1</u>
MREQ	IORQ
RFSH	HALT
E	TEST
ST	

Bit O LNAD/DATA. This bit controls the drive capability of the Address/Data bus output drivers. If this bit is set to 1, the output drive capability of the Address and Data bus outputs is reduced to 33 percent of its original drive capability.

ZiLOG

Data can be written into and read from the ASCI Transmit Data Register. If data is read from the ASCI Transmit Data Register, the ASCI data transmit operation is not affected by this READ operation.

ASCI Receive Shift Register 0,1 (RSR0,1). This register receives data shifted in on the RXA pin. When full, data is automatically transferred to the ASCI Receive Data Register (RDR) if it is empty. If RSR is not empty when the next incoming data byte is shifted in, an overrun error occurs. This register is not program accessible.

ASCI Receive Data FIFO 0,1 (RDR0, 1:I/O Address = **08H**, **09H**). The ASCI Receive Data Register is a read-only register. When a complete incoming data byte is assembled in RSR, it is automatically transferred to the 4 character Receive Data First-In First-Out (FIFO) memory. The oldest character in the FIFO (if any) can be read from the Receive Data Register (RDR). The next incoming data byte can be shifted into RSR while the FIFO is full. Thus, the ASCI receiver is well buffered.

ASCI STATUS FIFO

This four-entry FIFO contains Parity Error, Framing Error, Rx Overrun, and Break status bits associated with each character in the receive data FIFO. The status of the oldest character (if any) can be read from the ASCI status registers.



MPE: Multi-Processor Mode Enable (Bit 7). The ASCI features a multiprocessor communication mode that utilizes an extra data bit for selective communication when a number of processors share a common serial bus. Multiprocessor data format is selected when the MP bit in CNTLB is set to 1. If multiprocessor mode is not selected (MP bit in CNTLB = 0), MPE has no effect. If multiprocessor mode is selected, MPE enables or disables the wake-up feature as follows. If MBE is set to 1, only received bytes in which the multiprocessor bit (MPB) = 1 can affect the RDRF and error flags. Effectively, other bytes (with MPB = 0) are *ignored* by the ASCI. If MPE is reset to 0, all bytes, regardless of

the state of the MPB data bit, affect the REDR and error flags. MPE is cleared to 0 during RESET.

RE: Receiver Enable (Bit 6). When RE is set to 1, the ASCI transmitter is enabled. When TE is reset to 0, the transmitter is disables and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the previous contents of TDRE are held. TE is cleared to 0 in IOSTOP mode during RESET.

TE: Transmitter Enable (Bit 5). When TE is set to 1, the ASCI receiver is enabled. When \overline{TE} is reset to 0, the transmitter is disabled and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the pre-

ASCI STATUS REGISTER 0,1

Each ASCI channel status register (STAT0,1) allows interrogation of ASCI communication, error and modem control signal status, and the enabling or disabling of ASCI interrupts.





RDRF: Receive Data Register Full (Bit 7). RDRF is set to 1 when an incoming data byte is loaded into an empty Rx FIFO. If a framing or parity error occurs, RDRF is still set and the receive data (which generated the error) is still loaded into the FIFO. RDRF is cleared to 0 by reading RDR and most recently received character in the FIFO from IOSTOP mode, during RESET and for ASCI0 if the DCD0 input is auto-enabled and is negated (High).

OVRN: Overrun Error (Bit 6). An overrun condition occurs if the receiver finishes assembling a character but the Rx FIFO is full so there is no room for the character. However, this status bit is not set until the most recent character received before the overrun becomes the oldest byte in the FIFO. This bit is cleared when software writes a 1 to the EFR bit in the CNTLA register. The bit may also be cleared by RESET in IOSTOP mode or ASCIO if the DCDO pin is auto enabled and is negated (High).

Note: When an overrun occurs, the receiver does not place the character in the shift register into the FIFO, nor any subsequent characters, until the most recent good character enters the top of the FIFO so that OVRN is set. Software then writes a 1 to EFR to clear it.

PE: Parity Error (Bit 5). A parity error is detected when parity checking is enabled. When the MOD1 bit in the

CNTLA register is 1, a character is assembled in which the parity does not match the PEO bit in the CNTLB register. However, this status bit is not set until or unless the error character becomes the oldest one in the Rx FIFO. PE is cleared when software writes a 1 to the EFR bit in the CNTRLA register. PE is also cleared by RESET in IOSTOP mode, or on ASCIO, if the DCDO pin is auto-enabled and is negated (High).

FE: Framing Error (Bit 4). A framing error is detected when the stop bit of a character is sampled as O/SPACE. However, this status bit is not set until/unless the error character becomes the oldest one in the Rx FIFO. FE is cleared when software writes a 1 to the EFR bit in the CNTLA register. FE is also cleared by RESET in IOSTOP mode, or on ASCIO, if the DCDO pin is auto-enabled and is negated (High).

REI: Receive Interrupt Enable (Bit 3). RIE should be set to 1 to enable ASCI receive interrupt requests. When RIE is 1, the Receiver requests an interrupt when a character is received and RDRF is set, but only if neither DMA channel requires its request-routing field to be set to receive data from this ASCI. That is, if SM1–0 are 11 and SAR17–16 are 10, or DIM1 is 1 and IAR17–16 are 10, then ASCI1 does not request an interrupt for RDRF. If RIE is 1, either ASCI requests an interrupt when OVRN, PE or FE is set, and

ASCI EXTENSION CONTROL REGISTER CHANNEL 0 AND CHANNEL 1 (Continued)

Timer Data Register Channel 1 Low

Mnemonic TMDR1L Address 14H





Timer Data Register Channel 1 High

Mnemonic TMDR1H Address 15H



Figure 49. Timer Data Register 1 High

Timer Reload Register Channel 1 Low

Mnemonic RLDR1L Address 16





Timer Reload Register Channel 1 High

Mnemonic RLDR1H Address 17H



Figure 51. Timer Reload Register Channel 1 High

Free Running Counter (Read Only)

Mnemonic FRC Address 18H



Figure 52. Free Running Counter

DMA MEMORY ADDRESS REGISTER CHANNEL 1

The DMA Memory Address Register Channel 1 specifies the physical memory address for channel 1 transfers. The address may be a destination or a source memory location. The register contains 20 bits and may specify up to 1024 KB memory addresses.

DMA Memory Address Register, Channel 1L

Mnemonic MAR1L Address 28H



Figure 65. DMA Memory Address Register, Channel 1L

DMA Memory Address Register, Channel 1H

Mnemonic MAR1H Address 29H



Figure 66. DMA Memory Address Register, Channel 1H

DMA Memory Address Register, Channel 1B

Mnemonic MAR1B Address 2AH



Figure 67. DMA Memory Address Register, Channel 1B

DMA MODE REGISTER

The DMA Mode Register (DMODE) is used to set the addressing and transfer mode for channel 0.

DMA Mode Register

Mnemonic DMODE Address 31H





DM1, DM0: Destination Mode Channel 0 (Bits 5,4). This mode specifies whether the destination for channel 0 transfers is memory or I/O, and whether the address should be incremented or decremented for each byte transferred. DM1 and DM0 are cleared to 0 during RESET.

SM1, SM0: Source Mode Channel 0 (Bits 3, 2). This mode specifies whether the source for channel 0 transfers is memory or I/O, and whether the address should be incremented or decremented for each byte transferred.

T	able	15.	Channel	0	Source
				-	

Table 14. Channel 0 Destination							
DM1	DM0	Memory I/O	Memory Increment/Decrement				
0	0	Memory	+ 1				
0	1	Memory	-1				
1	0	Memory	fixed				
1	1	I/O	fixed				

			Memory
SM1	SM0	Memory I/O	Increment/Decrement
0	0	Memory	+ 1
0	1	Memory	-1
1	0	Memory	fixed
1	1	I/O	fixed

Table 16 indicates all DMA transfer mode combinations of DMO, DM1, SMO, and SM1. Because I/O to/from I/O transfers are not implemented, 12 combinations are available.

DM1	DM0	SM1	SM0	Transfer Mode	Address Increment/Decrement
0	0	0	0	Memory→Memory	SAR0 + 1, DAR0 + 1
0	0	0	1	Memory→Memory	SAR0-1, DAR0+1
0	0	1	0	Memory*→Memory	SAR0 fixed, DAR0+1
0	0	1	1	I/O→Memory	SAR0 fixed, DAR0+1
0	1	0	0	Memory→Memory	SAR0+1, DAR0-1
0	1	0	1	Memory→Memory	SAR0-1, DAR0-1
0	1	1	0	Memory*→Memory	SAR0 fixed, DAR0-1
0	1	1	1	I/O→Memory	SAR0 fixed, DAR0-1
1	0	0	0	Memory→Memory*	SAR0+1, DAR0 fixed
1	0	0	1	Memory→Memory*	SAR0-1, DAR0 fixed
1	0	1	0	Reserved	
1	0	1	1	Reserved	
1	1	0	0	Memory→I/O	SAR0+1, DAR0 fixed
1	1	0	1	Memory→I/O	SAR0-1, DAR0 fixed
1	1	1	0	Reserved	
1	1	1	1	Reserved	
Note: * Inc	ludes memo	ory mapped	I/O.		

Table 16. Transfer Mode Combinations

MMOD: Memory Mode Channel 0 (Bit 1). When channel 0 is configured for memory to/from memory transfers there is no Request Handshake signal to control the transfer timing. Instead, two automatic transfer timing modes are selectable: burst (MMOD = 1) and cycle steal (MMOD = 0). For burst memory to/from memory transfers, the DMAC takes control of the bus continuously until the DMA transfer

completes (as indicated by the byte count register = 0). In cycle steal mode, the CPU is provided a cycle for each DMA byte transfer cycle until the transfer is completed.

For channel 0 DMA with I/O source or destination, the selected Request signal times the transfer ignoring MMOD. MMOD is cleared to 0 during RESET.

INTERRUPT VECTOR LOW REGISTER

Bits 7–5 of the Interrupt Vector Low Register (I_L) are used as bits 7–5 of the synthesized interrupt vector during interrupts for the INT1 and INT2 pins and for the DMAs, ASCIs,

Interrupt Vector Low Register

Mnemonic: IL Address 33H



RESET (Figure 74).

Figure 74. Interrupt Vector Low Register (IL: I/O Address = 33H)

CTCs

INT/TRAP CONTROL REGISTER

This register is used in handling TRAP interrupts and to enable or disable Maskable Interrupt Level 0 and the $\overline{INT1}$ and $\overline{INT2}$ pins.

INT/TRAP Control Register Mnemonics ITC Address 34H



TRAP (Bit 7). This bit is set to 1 when an undefined opcode is fetched. TRAP can be reset under program control by writing it with a 0; however, TRAP cannot be written with 1 under program control. TRAP is reset to 0 during RESET.

UFO: Undefined Fetch Object (Bit 6). When a TRAP interrupt occurs, the contents of UFO allow the starting address of the undefined instruction to be determined. This interrupt is necessary because the TRAP may occur on either the second or third byte of the opcode. UFO allows the stacked PC value to be correctly adjusted. If UFO = 0, the first opcode should be interpreted as the stacked PC-1. If UFO = 1, the first opcode address is stacked PC-2. UFO is Read-Only.

ITE2, **1**, **0**: **Interrupt Enable 2**, **1**, **0** (**Bits 2–0**). ITE2 and ITE1 enable and disable the external interrupt inputs

INT2 and INT1, respectively. ITEO enables and disables interrupts from:

PRTs, and CSI/O. These three bits are cleared to 0 during

- ESCC Bidirectional Centronics controller
 - External interrupt input INTO

A 1 in a bit enables the corresponding interrupt level while a 0 disables it. A RESET sets ITE0 to 1 and clears ITE1 and ITE2 to 0.

TRAP Interrupt. The Z8S180/Z8L180 generates a TRAP sequence when an undefined opcode fetch occurs. This feature can be used to increase software reliability, implement an *extended* instruction set, or both. TRAP may occur during opcode fetch cycles and also if an undefined opcode is fetched during the interrupt acknowledge cycle for INTO when Mode O is used.

When a TRAP sequence occurs, the Z8S180/Z8L180:

- 1. Sets the TRAP bit in the Interrupt TRAP/Control (ITC) register to 1.
- 2. Saves the current Program Counter (PC) value, reflecting the location of the undefined opcode, on the stack.
- 3. Resumes execution at logical address 0.

Note: If logical address 0000H is mapped to physical address 00000H, the vector is the same as for RESET. In this case, testing the TRAP bit in ITC reveals whether the restart at physical address 00000H was caused by RESET or TRAP.

MMU COMMON BASE REGISTER

The Common Base Register (CBR) specifies the base address (on 4-KB boundaries) used to generate a 20-bit phys-

MMU Common Base Register

Mnemonic CBR Address 38H



Figure 78. MMU Common Base Register (CBR: I/O Address = 38H)

0 during RESET.

MMU BANK BASE REGISTER

The Bank Base Register (BBR) specifies the base address (on 4-KB boundaries) used to generate a 20-bit physical ad-

MMU Bank Base Register

Mnemonic BBR Address 39H



Figure 79. MMU Bank Base Register (BBR: I/O Address = 39H)

MMU COMMON/BANK AREA REGISTER

The Common/Bank Area Register (CBAR) specifies boundaries within the Z8S180/Z8L180 64-KB logical address space for up to three areas; Common Area), Bank Area and Common Area 1.

ical address for Common Area 1 accesses. All bits of CBR

dress for Bank Area accesses. All bits of BBR are reset to

are reset to 0 during RESET.

MMU Common/Bank Area Register

Mnemonic CBAR Address 3AH

Bit	7	6	5	4	3	2	1	0
	CA3	CA2	CA1	CA0	BA3	BA2	BA1	BAO
	R/W							

Figure 80. MMU Common/Bank Area Register (CBAR: I/O Address = 3AH)



Figure 87. 68-Pin PLCC Package Diagram